







Product Outline:

This is the small TOP LED with reflector type with single color led. This special package is ideal for customer's application in traffic signal and sign boards. With special binning technology, Quelighting is able to provide special binning for customer's needs

Features:

- Red color LED
- High brightness output @ 20mA,
- High driving current to 30mA.
- Package Dimension = 3.5mmX2.7mmX1.8mm
- MSL level 2
- RoHS compliant
- Custom Bin available upon special request
- View angel >110°
- AEC-Q101

Application:

- Architecture Lighting
- Sign board backlighting
- Emergency vehicle lighting
- Traffic signal lighting
- Automotive lighting

Compliance and Certification:

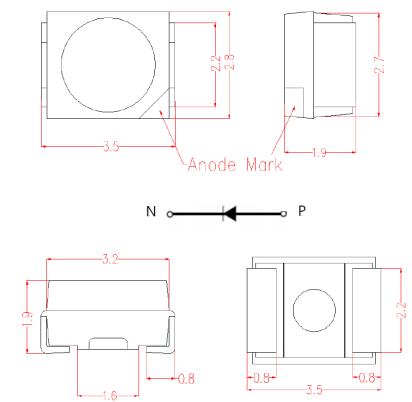






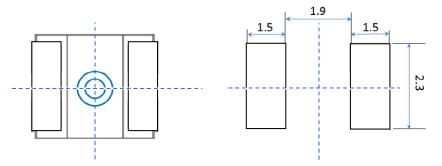


Mechanical Property: (Dimension)



* All dimensions are in millimeters, * Tolerances are ± 0.10mm.

Recommended Solder footprint:



- * All dimensions are in millimeters.
- * The LEDs is designed to be reflow soldered on to a PCB. IF dip soldered that QL cannot guarantee its reliability.
- * Reflow soldering must not be performed more than twice.



Characteristics

Absolute Maximum	(Ta=25℃)		
Parameter	Symbol	Rating	Unit
DC Forward Current	lf	30	mA
Power Dissipation	Pd	0.04	W
Pulse Forward Current	lfp	30	mA
Storage Temperature	Tstg	-40 ~ 105	°C
Operation Temperature	Topr	-30 ~ 105	°C
Soldering Temperature	Tsol	260 < 10 sec	°C
ESD (HBM)	ESD(HBM)	2000	V

(1) Proper current rating must be observed to maintain junction temperature below maximum at all time
(2) IFP Condition: Duty 1/10, Pulse within 10msec

Electrical / Optical Characteristic						a=25 oC)
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	Vf	20mA	1.8		2.6	V
View Angle	θ			120		deg

(1) Tolerance of measurement: VF=+/- 0.1V

Specification

	Product	Color	Vf(V) IF=20mA	Dominant Wavelength		s intensity A (mcd)
			IF=20MA	(nm) _	Min.	Тур.
	QLSP05R	Red	2.2	612~635	400	700
*т	a a r a n a a - 1 / 10 %					

*Tolerance = +/- 10%





Groups Dominate Wavelength (nm) Bin:

V	Condition			
Color	Code name	Low	High	Unit
	A1000	612	616	
	A2000	616	620	
Red	A3000	620	624	nm
	A4000	624	630	
	A5000	630	635	

Measurement tolerance is +/- 1nm

Forward Voltage (V_F) Bin:

N N	Condition			
Color	Code name	Low	High	unit
	А	1.9	2.05	
	В	2.05	2.2	
Red	С	2.2	2.35	V
	D	2.35	2.5	
	E	2.5	2.65	

The forward voltage tolerance is $\pm 0.1V$

Luminous Intensity Bin:

Intensity Rank (mcd) @ 20mA				
Code name	Min.	Max.	Units	
S1	400	500		
S2	500	600		
S3	600	700	mcd	
S4	700	800		
S5	800	900		

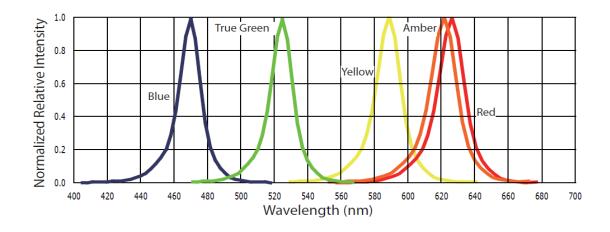
Luminous intensity tolerance is $\pm 7\%$



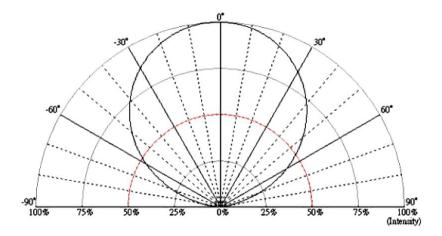




(1) Color Spectrum



(2). Typical Representative Spatial Radiation Pattern

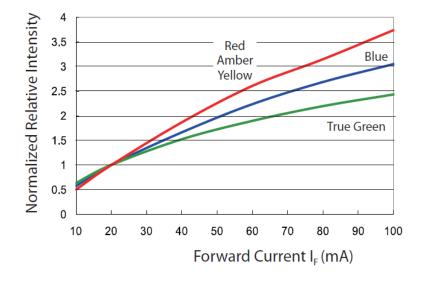




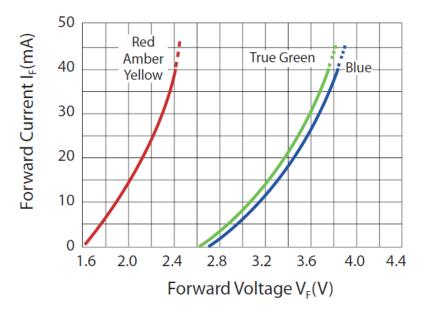




(3). Forward Current Characteristics



(4). Forward Current vs Forward Voltage







Reliability test:

No	Item	Condition	Time/Cycle	Sample size
1	Steady State Operating Life of Room Temperature	25°C Operating	1000 Hrs	20 pcs
2	Steady State Operating Life of Low Temperature -40 $^\circ\!\!\mathbb{C}$	-40°C Operating	1000 Hrs	20 pcs
3	Steady State Operating Life of Low Temperature $60^\circ\!\!\mathbb{C}$	60℃ Operating	1000 Hrs	20 pcs
4	Steady State Operating Life of Low Temperature 85 $^\circ\!{\rm C}$	85℃ Operating	1000 Hrs	20 pcs
5	Low temperature storage -40 $^{\circ}$ C	-40°C Storage	1000 Hrs	20 pcs
6	High temperature storage 100 $^\circ\!\mathrm{C}$	100°C Storage	1000 Hrs	20 pcs
7	Steady State Operating Life of High Humidity Heat $60^\circ\!\!\!\!\!C90\%$	60°C/90% Operating	1000 Hrs	20 pcs
8	Steady State Pulse Operating Life Condition	25° C 10Hz duty=1/10 Operating	200 Cycle	20 pcs
9	Resistance to soldering heat on PCB (JEDEC MSL3)	pre-store@60℃, 60%RH for 52hrs Tsld max.=260 10sec	3 Times	20 pcs
10	Heat Cycle Test (JEDEC MRC)	25℃~65℃~-10℃, 90%RH, 24hr/1cycle	10 Cycle	20 pcs
11	Thermal shock	-40℃/ 20minr~ 5minr~100℃ /20min	300 Cycle	20 pcs

Judgment Criteria:

ltem	Symbol	Test Condition	Judgment Criteria
Forward Voltage	Vf	20 mA	∆Vf< 10%
Luminous Flux	lv	20 mA	∆lv< 30%

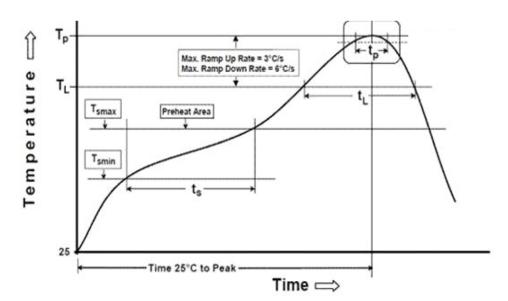






■ Solder Profile:

-The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

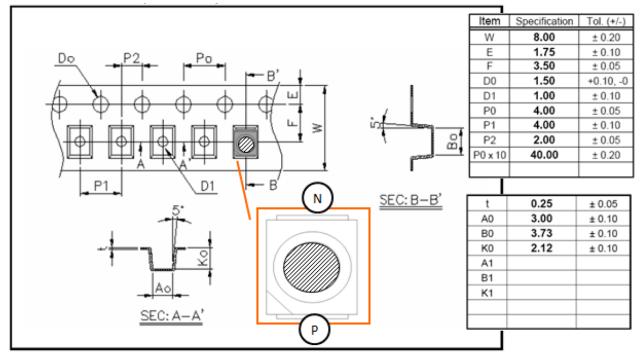


Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly		
Temperature Min(T _{smin})	100℃	150℃		
Temperature Max(T _{smax})	150℃	200℃		
Time(t _a) from (T _{smin} to T _{smax})	60-120 seconds	60-120 seconds		
Ramp-up rate(T_L to T_P)	3℃/second max.	3℃/second max.		
Liquidous Temperature(T_L)	183℃	217 ℃		
Time(t_L) maintained above T_L	60-150 seconds	60-150 seconds		
Peak package body temperature(T _P)	235℃	260℃		
Time within 5 $^\circ\!\!\mathbb{C}$ of Actual Peak	20seconds*	20		
temperature (t _p)	ZUSECONUS	30 seconds*		
Ramp-down rate(T _P to T_L)	6℃/second max.	6℃/second max.		
Time 25 $^\circ\!\!\mathbb{C}$ to peak temperature	6 minutes max.	8 minutes max.		
* Tolerance for peak profile temperature (T _P) is defined as a supplier minimum and a user maximum.				





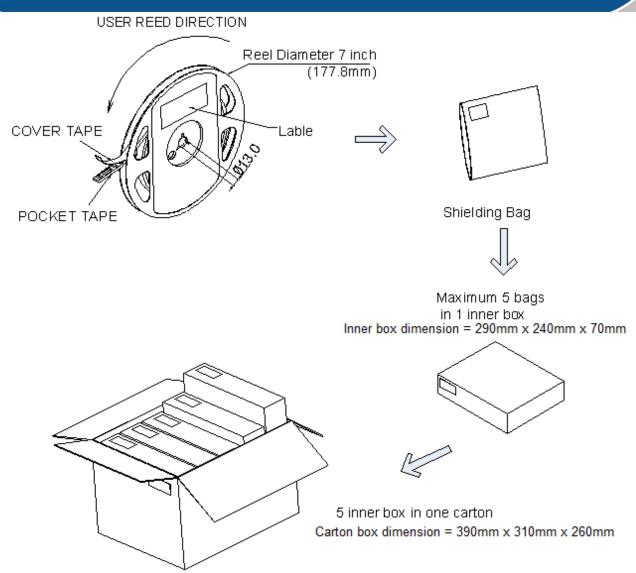
Taping & Packing:



Unit : mm











QLSP05R PLCC 2 Series V1.0

Labeling		
Quantity: XXXX		QueLighting
Quelighting P/N: XXXXXX		
Lot number: XXXXX		
Iv Bin: XX Color Bin: XX	Vf Bin: XX	Date Code: XXXX

Ordering Information:

Part #	Multiple Quantities	Quantity per Reel
QLSP05R PLCC 2		1000, 2000, 4000pcs





Revision History:

Revision Date:	Changes:	Version #:
07-04-2020	Initial release	1.0

